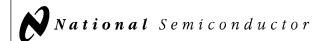
# 54F827,74F827,74F828

54F827 74F827 74F828 10-Bit Buffers/Line Drivers



Literature Number: SNOS218A



# 54F/74F827 ◆ 74F828 10-Bit Buffers/Line Drivers

### **General Description**

The 'F827 and 'F828 10-bit bus buffers provide high performance bus interface buffering for wide data/address paths or buses carrying parity. The 10-bit buffers have NOR output enables for maximum control flexibility.

The 'F827 and 'F828 are functionally- and pin-compatible to AMD's Am29827 and Am29828. The 'F828 is an inverting version of the 'F827.

#### **Features**

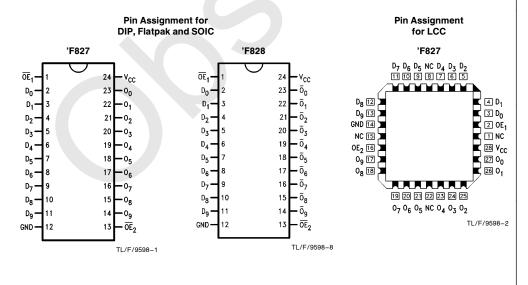
- TRI-STATE® output
- 'F828 is inverting
- Direct replacement for AMD's Am29827 and Am29828

Commercial	Military	Package Number	Package Description
74F827SPC		N24C	24-Lead (0.300" Wide) Molded Dual-In-Line
	54F827SDM (Note 2)	J24F	24-Lead (0.300" Wide) Ceramic Dual-In-Line
74F827SC (Note 1)		M24B	24-Lead (0.300" Wide) Molded Small Outline, JEDEC
	54F827FM (Note 2)	W24C	24-Lead Cerpack
	54F827LM (Note 2)	E28A	24-Lead Ceramic Leadless Chip Carrier, Type C
74F828SPC		N24C	24-Lead (0.300" Wide) Molded Dual-In-Line
74F828SC (Note 1)		M24B	24-Lead (0.300" Wide) Molded Small Outline, JEDEC

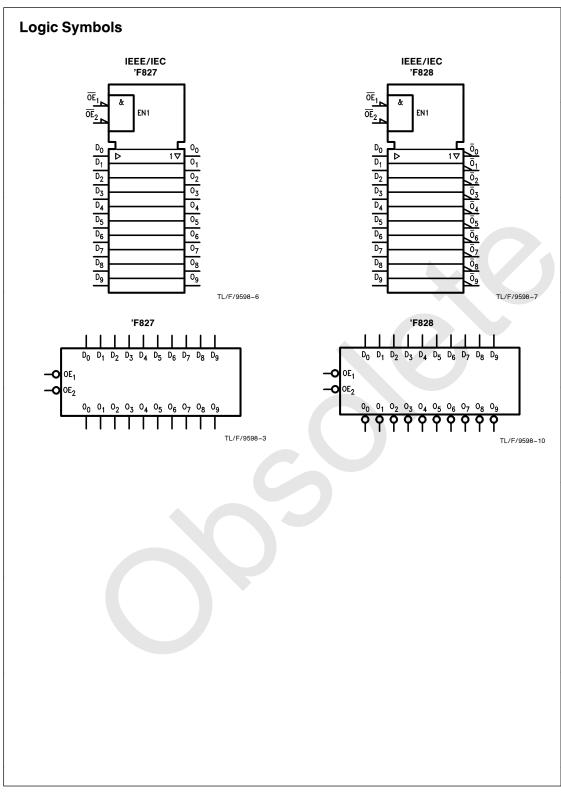
Note 1: Devices also available in 13" reel. Use suffix = SCX.

Note 2: Military grade device with environmental and burn-in processing. Use suffix = SDMQB, FMQB and LMQB.

#### **Connection Diagrams**



TRI-STATE® is a registered trademark of National Semiconductor Corporation.



# **Unit Loading/Fan Out**

		54F/74F				
Pin Names	n Names Description		Input I <sub>IH</sub> /I <sub>IL</sub> Output I <sub>OH</sub> /I <sub>OL</sub>			
$\overline{OE}_1, \overline{OE}_2$	Output Enable Input	1.0/1.0	20 μA/ - 0.6 mA			
$D_0-D_7$	Data Inputs	1.0/1.0	20 μA/ - 0.6 mA			
00-07	Data Outputs, TRI-STATE	600/106.6 (80)	-12 mA/64 mA (48 mA)			

### **Functional Description**

The 'F827 and 'F828 are line drivers designed to be employed as memory address drivers, clock drivers and bus-oriented transmitters/receivers which provide improved PC board density. The devices have TRI-STATE outputs controlled by the Output Enable (OE) pins. The outputs can sink 64 mA (48 mA mil) and source 15 mA. Input clamp diodes limit high-speed termination effects.

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 $\bar{0}_5$ 

#### **Function Table**

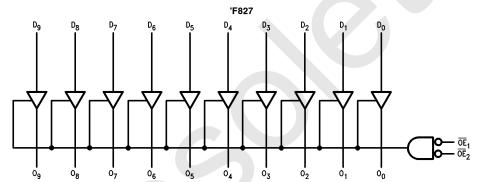
Inputs		Out	puts			
ŌĒ	Dn	C	) <sub>n</sub>	Function		
	υn	'F827	'F828			
L	Н	Н	L	Transparent		
L	L	L	Н	Transparent		
Н	Χ	Z	Z	High Z		

H = HIGH Voltage level

L = LOW Voltage Level Z = High Impedance

X = Immaterial

## **Logic Diagrams**



TL/F/9598-4

Please note that this diagram is provided only for the understanding of logic operations and should not be used to estimate propagation delays. 'F828

TL/F/9598-11

Please note that this diagram is provided only for the understanding of logic operations and should not be used to estimate propagation delays.

 $\bar{o}_3$ 

 $\bar{\rm o}_2$ 

 $\bar{0}_1$ 

 $\bar{o}_0$ 

 $\bar{\mathbf{0}}_{\mathbf{4}}$ 

#### **Absolute Maximum Ratings** (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

 $\begin{array}{lll} \mbox{Storage Temperature} & -65^{\circ}\mbox{C to} + 150^{\circ}\mbox{C} \\ \mbox{Ambient Temperature under Bias} & -55^{\circ}\mbox{C to} + 125^{\circ}\mbox{C} \\ \mbox{Junction Temperature under Bias} & -55^{\circ}\mbox{C to} + 175^{\circ}\mbox{C} \\ \mbox{Plastic} & -55^{\circ}\mbox{C to} + 150^{\circ}\mbox{C} \\ \end{array}$ 

V<sub>CC</sub> Pin Potential to

Voltage Applied to Output

in HIGH State (with  $V_{CC} = 0V$ )

 $\begin{array}{ll} \text{Standard Output} & -0.5 \text{V to V}_{\text{CC}} \\ \text{TRI-STATE Output} & -0.5 \text{V to } +5.5 \text{V} \end{array}$ 

Current Applied to Output in LOW State (Max)

twice the rated  $I_{OL}$  (mA)

**Note 1:** Absolute maximum ratings are values beyond which the device may be damaged or have its useful life impaired. Functional operation under these conditions is not implied.

Note 2: Either voltage limit or current limit is sufficient to protect inputs.

# **Recommended Operating Conditions**

Free Air Ambient Temperature

Supply Voltage

Military +4.5V to +5.5V Commercial +4.5V to +5.5V

#### **DC Electrical Characteristics**

Symbol	Parameter		54F/74F			Units	v <sub>cc</sub>	Conditions	
Symbol	raiaille	tei	Min Typ Max		Ullits	VCC	Conditions		
V <sub>IH</sub>	Input HIGH Voltage		2.0			V		Recognized as a HIGH Signal	
V <sub>IL</sub>	Input LOW Voltage				0.8	V		Recognized as a LOW Signal	
V <sub>CD</sub>	Input Clamp Diode Vo	oltage			-1.2	V	Min	$I_{\text{IN}} = -18 \text{ mA}$	
V <sub>OH</sub>	Output HIGH Voltage	54F 10% V <sub>CC</sub> 54F 10% V <sub>CC</sub> 74F 10% V <sub>CC</sub> 74F 10% V <sub>CC</sub> 74F 5% V <sub>CC</sub>	2.4 2.0 2.4 2.0 2.7			V	Min	$I_{OH} = -3 \text{ mA}$ $I_{OH} = -12 \text{ mA}$ $I_{OH} = -3 \text{ mA}$ $I_{OH} = -15 \text{ mA}$ $I_{OH} = -3 \text{ mA}$	
V <sub>OL</sub>	Output LOW Voltage	54F 10% V <sub>CC</sub> 74F 10% V <sub>CC</sub>			0.55 0.55	٧	Min	I <sub>OL</sub> = 48 mA I <sub>OL</sub> = 64 mA	
I <sub>IH</sub>	Input HIGH Current	54F 74F			20.0 5.0	μΑ	Max	V <sub>IN</sub> = 2.7V	
I <sub>BVI</sub>	Input HIGH Current Breakdown Test	54F 74F			100 7.0	μΑ	Max	V <sub>IN</sub> = 7.0V	
I <sub>CEX</sub>	Output HIGH Leakage Current	54F 74F			250 50	μΑ	Max	$V_{OUT} = V_{CC}$	
V <sub>ID</sub>	Input Leakage Test	74F	4.75			٧	0.0	$I_{\text{ID}} = 1.9  \mu\text{A}$ All Other Pins Grounded	
I <sub>OD</sub>	Output Leakage Circuit Current	74F			3.75	μΑ	0.0	V <sub>IOD</sub> = 150 mV All Other Pins Grounded	
I <sub>IL</sub>	Input LOW Current				-0.6	mA	Max	V <sub>IN</sub> = 0.5V	
l <sub>OZH</sub>	Output Leakage Current				50	μΑ	Max	V <sub>OUT</sub> = 2.7V	
I <sub>OZL</sub>	Output Leakage Current				-50	μΑ	Max	V <sub>OUT</sub> = 0.5V	
Ios	Output Short-Circuit Current		-100		-225	mA	Max	V <sub>OUT</sub> = 0V	

### DC Electrical Characteristics (Continued)

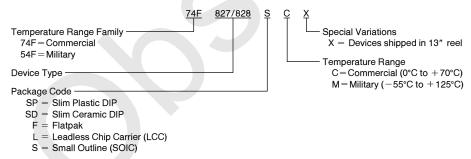
Symbol	Parameter		54F/74F		Units	V <sub>CC</sub>	Conditions	
Symbol	raiametei	Min	Тур	Max	Onits	<b>VCC</b>		
I <sub>ZZ</sub>	Bus Drainage Test			500	μΑ	0.0V	V <sub>OUT</sub> = 5.25V	
Іссн	Power Supply Current ('F827)		30	45	mA	Max	V <sub>O</sub> = HIGH	
I <sub>CCL</sub>	Power Supply Current ('F827)		60	90	mA	Max	$V_O = LOW$	
Iccz	Power Supply Current ('F827)		40	60	mA	Max	V <sub>O</sub> = HIGH Z	
ICCH	Power Supply Current ('F828)		14	20	mA	Max	V <sub>O</sub> = HIGH	
ICCL	Power Supply Current ('F828)		56	85	mA	Max	$V_O = LOW$	
Iccz	Power Supply Current ('F828)		35	50	mA	Max	V <sub>O</sub> = HIGH Z	

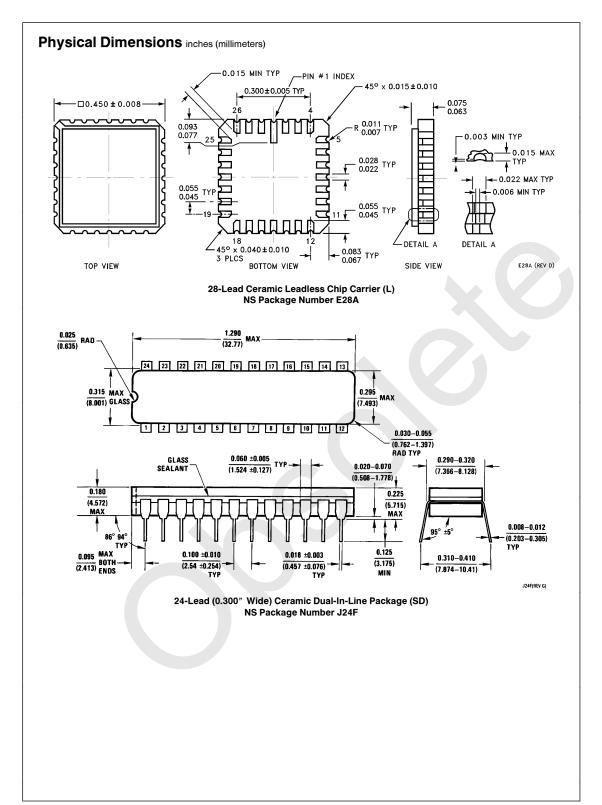
#### **AC Electrical Characteristics**

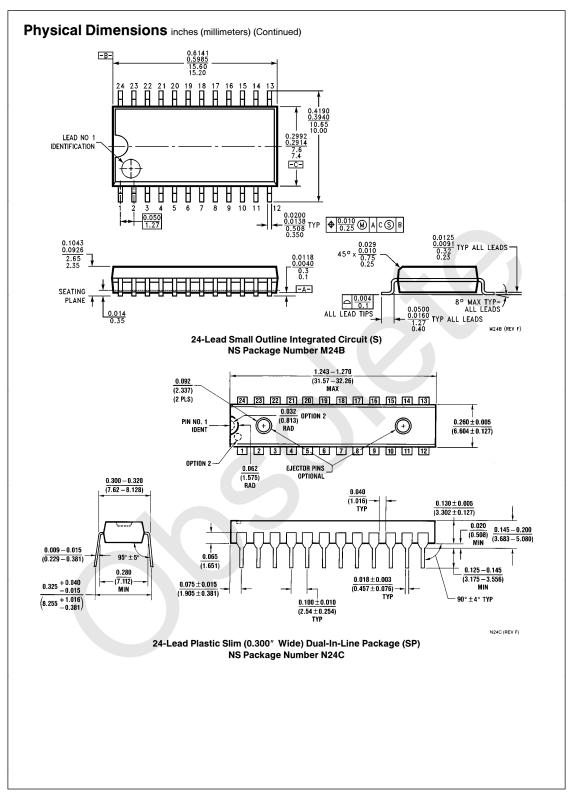
Symbol	Parameter	·	74F T <sub>A</sub> = +25°0 C <sub>C</sub> = +5.0 C <sub>L</sub> = 50 pF	V	T <sub>A</sub> , V <sub>C</sub>	64F CC = Mil 50 pF	T <sub>A</sub> , V <sub>CC</sub>	4F = Com 50 pF	Units
		Min	Тур	Max	Min	Max	Min	Max	
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation Delay Data to Output ('F827)	1.0 1.5	3.0 3.3	5.5 5.5	1.0 1.5	7.5 7.0	1.0 1.5	6.5 6.0	ns
t <sub>PLH</sub>	Propagation Delay Data to Output ('F828)	1.0 1.0	3.0 2.0	5.0 4.0			1.0 1.0	5.5 4.0	ns
t <sub>PZH</sub>	Output Enable Time OE to On	3.0 3.5	5.7 6.8	9.0 11.5	2.5 3.0	10.0 12.5	2.5 3.0	9.5 12.0	ns
t <sub>PHZ</sub>	Output Disable Time OE to On	1.5 1.0	3.3 3.5	8.0 8.0	1.5 1.0	9.0 9.0	1.5 1.0	8.5 8.5	ns

#### **Ordering Information**

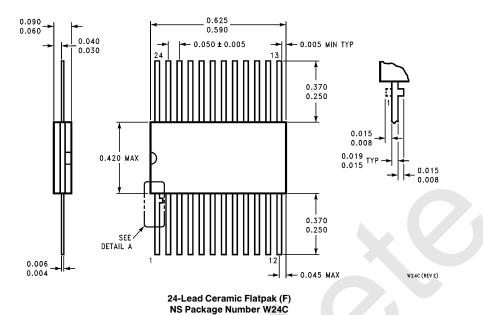
The device number is used to form part of a simplified purchasing code where the package type and temperature range are defined as follows:







# Physical Dimensions inches (millimeters) (Continued)



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